

PTC thermistors for overcurrent protection in telecom applications

Telecom Pair Protector (TPP), SMD

Series/Type:

Date:

November 2009

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Applications

- Overcurrent protection for telecom applications
- Suitable for line card applications e.g. POTS, access networks, customer premises equipment (CPE) or integrated voice data (IVD)

Features

- Two resistance-matched PTCs in a plastic housing
- Compliant with ITU-T standards
 - basic-level lightning surges (10/700 μs)
 - basic-level power induction (600 V, 1 A, 0.2 s)
 - power contact criteria A/B (230 V, 15 min.)
- Compliant with GR1089 AC power contact 120 V, 25 A, 15 min.
- Suitable for continuous connection to mains voltages of 110/230 V AC in tripped (high-ohmic) condition
- Housing material to UL94-V0
- UL approval to UL 1434 (file number E69802) for $R_R \ge 35 \Omega$
- Tight resistance matching maintained after switching
- Negligible resistance drift after reflow soldering or switching
- Marked with manufacturer's logo, type designation and date code
- RoHS-compatible

Options

Alternative tolerances and resistances on request

Delivery mode

- T15** and T16**: Blister tape, 330-mm reel with 16-mm tape, taping to IEC 60286-3
- T17** and T18**: Blister tape, 380-mm reel with 24-mm tape, taping to IEC 60286-3

General technical data

Max. operating voltage		V _{max}	245	V AC
Operating temperature range	(V = 0)	T _{op}	-20/+125	°C
Operating temperature range	(V = 230 V)	T _{op}	0/+70	°C
Insulating test voltage between PTC1 and PTC2		V _{ins}	> 3	kV
Resistance matching in one housing	for $R_R \le 4.75 \ \Omega$	$ R_2 - R_1 $	< 0.5	Ω
Resistance matching in one housing	for $R_R \le 50 \ \Omega$	$\left R_{2}-R_{1}\right $	< 1.0	Ω
Resistance matching in one housing	for $R_R = 75 \Omega$	$ R_2 - R_1 $	< 2.0	Ω

Internal circuit





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Electrical specifications and ordering codes

Туре	R _B	ΔR_{B}	I _B	I _B	l _s	I _{Smax}	Ordering code
турс	· .u	n	@ 25 °C	@ 70 °C	@ 25 °C	@ 230 V AC	
	Ω	%	mA	mA	mA	A	
Compone						~	
	.		1		1	1	
T1535	35	+15/-20	110	70	230	2.5	B59535T1120A262
T1550	50	±15	90	60	190	2.5	B59550T1120A262
Compone	nt height	8.5 mm					
T1510	10	±20	180	120	360	1.0	B59510T1120A062
T1525	25	±20	130	85	260	2.8	B59525T1120A062
Compone	nt height	9.9 mm					
T1635	35	+15/-20	110	70	230	4.6	B59635T1120A062
T1650	50	±15	90	60	190	2.5	B59650T1120A062
Compone	nt height	10.5					
T1725	25	±20	130	85	260	2.8	B59725T1120A062
T1735	35	+15/-20	110	70	230	4.6	B59735T1120A062
T1750	50	±15	90	60	190	2.5	B59750T1120A062
Component height 11.5							
T1805	4.75	+15/-20	160	70	370	1.0	B59805T1080A062
T1810	10	±20	180	120	360	1.0	B59810T1120A062
T1825	25	±20	130	85	260	2.8	B59825T1120A062
T1835	35	+15/-20	110	70	230	4.6	B59835T1120A062
T1850	50	±15	90	60	190	2.5	B59850T1120A062
T1875	75	±20	70	40	150	2.5	B59875T1120A062



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Switching times and ordering codes

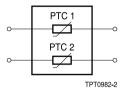
Туре	t _s (typ.) @ I _{Smax} ,	t _s (typ.) @ 1 A,	t _s (typ.) @ 500 mA,	Ordering code		
	230 V AC	230 V AC	230 V AC			
	s	s	s			
	1.5	-	3			
	ent height 7.5 n		r	1		
T1535	0.07	0.4	1.6	B59535T1120A262		
T1550	0.05	0.3	1.1	B59550T1120A262		
Compone	Component height 8.5 mm					
T1510	3.6	3.6	16	B59510T1120A062		
T1525	0.2	1.4	6	B59525T1120A062		
Compone	ent height 9.9 n	ım				
T1635	0.04	0.8	3.4	B59635T1120A062		
T1650	0.1	0.6	2.4	B59650T1120A062		
Compone	Component height 10.5					
T1725	0.3	1.1	4	B59725T1120A062		
T1735	0.04	0.8	3.4	B59735T1120A062		
T1750	0.1	0.6	2.4	B59750T1120A062		
Component height 11.5						
T1805	4	4	20	B59805T1080A062		
T1810	3.8	3.8	19.0	B59810T1120A062		
T1825	0.2	1.5	6.5	B59825T1120A062		
T1835	0.06	1.1	4.5	B59835T1120A062		
T1850	0.13	0.8	3.1	B59850T1120A062		
T1875	0.12	0.7	2.6	B59875T1120A062		



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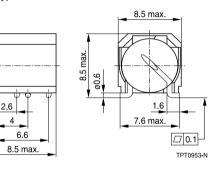
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Internal circuit

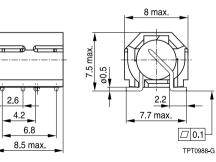


Dimensional drawings in mm

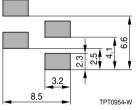
For type T1510 and T1525



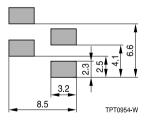
For type T1535 and T1550



Solder pad



Solder pad



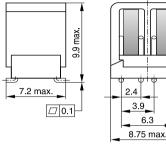


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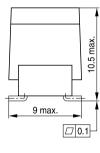
Dimensional drawings in mm

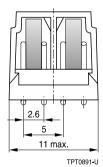
For type T1635 and T1650



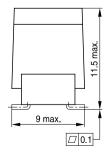
TPT0911-D

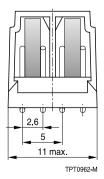
For type T1725, T1735, T1750



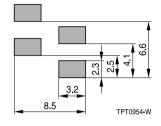


For type T1805 ... T1875

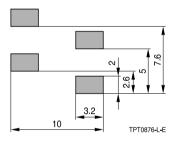




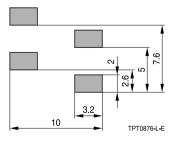
Solder pad



Solder pad







Please read *Cautions and warnings* and *Important notes* at the end of this document.



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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 20%
cycling		Number of cycles: 10	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op,max} (V _{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 V), T_2 = T_{op,max} (0 V)$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, Test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3×2 h	
		Test according to IEC 60068-2-6, Test Fc	
Shock	IEC 60738-1	Acceleration: 390 m/s ²	< 5%
		Pulse duration: 6 ms; 6×4000 pulses	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max} (0 V)$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 V)$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	



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ITU performance overview and test conditions

	Test no.	ITU K20 ITU K21		ITU K45			
		Basic test level	Enhanced test level	Basic test level	Enhanced test level	Basic test level	Enhanced test level
Power induction	1	A	Α	Α	Α	Α	A
	2	В	С	В	С	В	С
Power contact	3	D	E	D	E	D	E
Lightning surge	4	F	G	G	G	G	G
	5	Н	Н	Н	Ι	Н	Н

600 V AC, R = 600 Ω, t = 0.2 s, criteria A 600 V AC, R = 600 Ω, t = 1.0 s, with GDT, criteria A 1500 V AC, R = 200 Ω, t = 2.0 s, with GDT, criteria A
1500 V AC, R = 200 Ω , t = 2.0 s, with GDT, criteria A
230 V AC, t = 15 min, R = 10 1000 Ω, criteria B
230 V AC, t = 15 min, R = 10, 20, 40, 80, 1000 Ω, criteria B, R = 160, 300, 600 Ω, criteria A
$U_{c(max)}$ = 1.0 kV, R = 25 Ω , t = 10/700 µs, without GDT, criteria A
$U_{c(max)}$ = 1.5 kV, R = 25 Ω , t = 10/700 µs, without GDT, criteria A
$U_{c(max)}$ = 4.0 kV, R = 25 $\Omega,$ t = 10/700 $\mu s,$ with GDT, criteria A
$U_{c(max)}$ = 6.0 kV, R = 25 $\Omega,$ t = 10/700 $\mu s,$ with GDT, criteria A

Criteria A: no damage, function must be fulfilled. Criteria B: no fire hazard.

Electrical requirements according to GR1089 standard for AC power contact

AC voltage: 120 V, 50 Hz, short circuit current 25 A, time 15 min, criteria A.



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).



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Symbols and terms

А	Area
C _{th}	Heat capacity
f	Frequency
I	Current
I _{max}	Maximum current
I _R	Rated current
I _{PTC}	PTC current
l _r	Residual currrent
l _{r,oil}	Residual currrent in oil (for level sensors)
I _{r,air}	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
ls	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V_{max} , charging of capacitor
N _f	Switching cycles at V_{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P _{diss}	Dissipation power
R _{min}	Minimum resistance
R _R	Rated resistance
ΔR_R	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
Rs	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅
Т	Temperature
t	Time
T _A	Ambient temperature
t _a	Thermal threshold time
Tc	Ferroelectric Curie temperature



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t _E	Settling time (for level sensors)
T _R	Rated temperature
T_{sense}	Sensing temperature
T _{op}	Operating temperature
T _{PTC}	PTC temperature
t _R	Response time
T _{ref}	Reference temperature
T _{Rmin}	Temperature at minimum resistance
ts	Switching time
T_{surf}	Surface temperature
UCT	Upper category temperature
V or $V_{\mbox{\scriptsize el}}$	Voltage (with subscript only for distinction from volume)
V _{RMS}	Root-mean-square value of voltage
V_{BD}	Breakdown voltage
V _{ins}	Insulation test voltage
$V_{\text{link,max}}$	Maximum link voltage
V _{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V _{meas}	Measuring voltage
V _{meas,max}	Maximum measuring voltage
V _R	Rated voltage
V_{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
τ_{th}	Thermal cooling time constant
λ	Failure rate
е	Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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